

Special Invited Session 03

Flexible Functional Materials and Devices

This session focuses on the interdisciplinary research and technological innovations in flexible functional materials and devices, aiming to address emerging challenges in wearable electronics, soft robotics, biomedical systems, energy conversion/storage, and adaptive structures. We invite contributions on the design, synthesis, characterization, and application of materials with tailored mechanical, electrical, optical, and thermal properties, as well as their integration into functional devices.



2026 IEEE 21st International Conference on Nano/Micro Engineered and Molecular Systems

April 17-21, 2026 Chengdu, China

Paper Submission

For the initial submission, the authors can select one of the following two types:

- Type 1: full paper (4-6 pages)
- Type 2: extended abstract (2 pages)

*Note:

▪ **View more on website:**

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“SIS03 – Flexible Functional Materials and Devices.”

Special Invited Session Chairs



Taisong Pan

University of Electronic Science and Technology of China, China



Kan Li

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Important Dates

Initial Submission (Full Paper or Extended Abstract)	Jan. 31, 2026
Notification of Acceptance	Feb. 10, 2026
Late-News Submission Deadline	Feb. 28, 2026
Early Registration Deadline	Mar. 10, 2026
Presentation-Only Submission Deadline	Mar. 10, 2026
Final Submission Deadline	Mar. 10, 2026

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